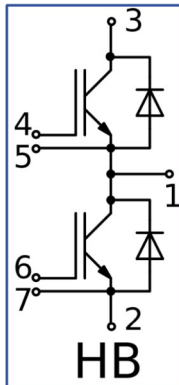
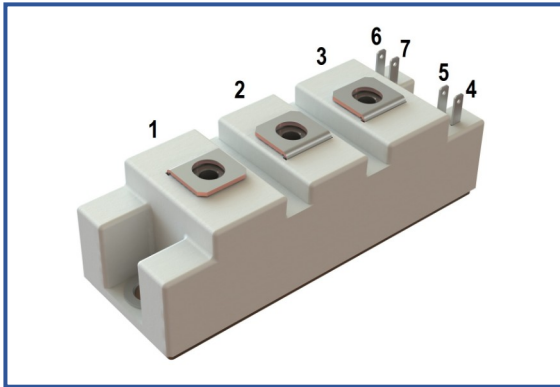


## Industry standard 34mm IGBT module

1200 V 150 A


**Chip features**

- IGBT chip
  - Trench FS
  - low  $V_{CE(sat)}$  value
  - 10  $\mu$ s short circuit of 150°C
  - square RBSOA of 2xI<sub>c</sub>
  - low EMI
- FRD chip
  - fast and soft reverse recovery
  - low voltage drop

**Design features**

- copper baseplate
- Al<sub>2</sub>O<sub>3</sub> DBC substrate
- ultrasonically welded power terminals
- Improved thermal cycling
- RoHS compliant

**Typical application**

- AC motor drives
- solar inverter
- air conditioning
- high power converters and UPS

**Maximum rated values**

Definition	Symbol	Conditions	Value	Unit
<b>IGBT</b>				
Collector-Emitter voltage	$V_{CES}$	$V_{GE} = 0$ .	1200	V
Maximum allowable collector current (continuous)	$I_{C 25}$	$T_{vj(max)} = 175^{\circ}C; T_c = 25^{\circ}C$ .	-	A
	$I_{C 80}$	$T_{vj(max)} = 175^{\circ}C; T_c = 80^{\circ}C$ .	150	A
Repetitive peak collector current*1	$I_{CRM}$	$I_{CRM} = 2 \times I_{C nom}; t_p = 1 \text{ ms}$ .	300	A
Short-circuit duration	$t_{psc}$	$T_{vj} = 25^{\circ}C; V_{GE} = \pm 15 \text{ V}; V_{CE} = 500 \text{ V}; R_{G on} = R_{G off} = 2.2 \Omega; I_{C max} < 590 \text{ A}$ .	10	$\mu$ s
		$T_{vj} = 150^{\circ}C; V_{GE} = \pm 15 \text{ V}; V_{CE} = 500 \text{ V}; R_{G on} = R_{G off} = 2.2 \Omega; I_{C max} < 518 \text{ A}$ .	10	
Gate-Emitter voltage	$V_{GES}$		$\pm 20$	V
Junction operating temperature	$T_{vj(op)}$		-40...+150	°C
<b>Inverse diode \ Freewheeling diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$	$V_{GE} = 0 \text{ V}$ .	1200	V
Maximum allowable forward current (continuous)	$I_{F 25}$	$T_{vj(max)} = 175^{\circ}C; T_c = 25^{\circ}C$ .	-	A
	$I_{F 80}$	$T_{vj(max)} = 175^{\circ}C; T_c = 80^{\circ}C$ .	150	A
Repetitive peak forward current*1	$I_{FRM}$	$I_{FRM} = 2 \times I_{F nom}; t_p = 1 \text{ ms}$ .	300	A
Junction operating temperature	$T_{vj(op)}$		-40...+150	°C
<b>Module</b>				
Storage temperature	$T_{stg}$		-40...+50	°C
Isolation voltage	$V_{isol}$	AC sin 50 Hz; t = 1 min.	4000	V

\*1 Pulse width and repetition rate should be such that device junction temperature does not exceed maximum  $T_{vj}$  rating

**Characteristics**

Definition	Symbol	Conditions	Value			Unit	
			min.	typ.	max.		
<b>IGBT</b>							
Collector-Emitter saturation voltage	$V_{CEsat}$	$V_{GE} = +15\text{ V}; I_C = 150\text{ A}; t_u = 1000\ \mu\text{s}.$	$T_{vj} = 25^\circ\text{C}$	-	2.18	2.65	V
			$T_{vj} = 150^\circ\text{C}$	-	2.66	3.00	V
Gate-Emitter threshold voltage	$V_{GE(th)}$	$I_C = 6\text{ mA}; V_{CE} = V_{GE}; T_{vj} = 25^\circ\text{C}; t_u = 2\text{ ms}.$		5.20	5.80	6.40	V
Collector-Emitter cut-off current	$I_{CES}$	$V_{CE} = 1200\text{ V}; t_u = 50\text{ ms}; V_{GE} = 0.$	$T_{vj} = 25^\circ\text{C}$	-	-	100	$\mu\text{A}$
			$T_{vj} = 150^\circ\text{C}$	-	-	9.0	$\text{mA}$
Gate-Emitter leakage current	$I_{GES}$	$V_{CE} = 0; V_{GE} = \pm 20\text{ V}; T_{vj} = 25^\circ\text{C}; t_u = 30\text{ ms}.$		-	-	100	nA
Input capacitance	$C_{ies}$	$V_{CE} = 10\text{ V}; V_{GE} = 0\text{ V};$		-	11.40	-	nF
Reverse transfer capacitance	$C_{res}$	$f = 1\text{ MHz}; T_{vj} = 25^\circ\text{C}.$		-	0.40	-	nF
Total gate charge	$Q_G$	$I_G = 20\text{ mA}; V_{CE} = 600\text{ V}; V_{GE} = -15\dots+15\text{ V}.$		-	-	620	nC
Internal gate resistance	$R_{Gint}$	$T_{vj} = 25^\circ\text{C}.$		-	3.80	-	$\Omega$
Turn-on delay time	$t_{d(on)}$		$T_{vj} = 25^\circ\text{C}$	-	-	149	ns
			$T_{vj} = 150^\circ\text{C}$	-	-	153	
Rise time	$t_{ri}$	$V_{CE} = 600\text{ V}; V_{GE} = \pm 15\text{ V};$	$T_{vj} = 25^\circ\text{C}$	-	-	47	ns
			$T_{vj} = 150^\circ\text{C}$	-	-	50	
Turn-on energy	$E_{on}$	$I_{Cmax} = 150\text{ A}; R_G = 2.2\ \Omega;$	$T_{vj} = 25^\circ\text{C}$	-	-	8.0	mJ
			$T_{vj} = 150^\circ\text{C}$	-	-	16.0	
Turn-off delay time	$t_{d(off)}$	$L_s = 56\text{ nH}.$	$T_{vj} = 25^\circ\text{C}$	-	-	202	ns
			$T_{vj} = 150^\circ\text{C}$	-	-	247	
Fall time	$t_{fi}$		$T_{vj} = 25^\circ\text{C}$	-	-	138	ns
			$T_{vj} = 150^\circ\text{C}$	-	-	153	
Turn-off energy	$E_{off}$		$T_{vj} = 25^\circ\text{C}$	-	-	9.0	mJ
			$T_{vj} = 150^\circ\text{C}$	-	-	11.0	
Collector-emitter threshold voltage	$V_{CE0}$	$V_{GE} = +15\text{ V}; T_{vj} = 150^\circ\text{C};$		-	-	1.06	V
On-State slope resistance (IGBT)	$r_{CE0}$	$I_{CE1} = 38\text{ A}; I_{CE2} = 150\text{ A}; t_u = 1000\ \mu\text{s}.$		-	-	10.63	$\text{m}\Omega$
Thermal resistance junction to case	$R_{th(j-c)}$	$\text{DC}; I_{CE} = 120 \pm 10\text{ A}; I_{test} = 0.5\text{ A}; V_{GE} = +15\text{ V}.$		-	-	0.190	K/W
<b>Inverse diode \ Freewheeling diode</b>							
Forward voltage drop	$V_F$	$I_F = 150\text{ A}; V_{GE} = 0; t_u = 1000\ \mu\text{s}.$	$T_{vj} = 25^\circ\text{C}$	-	2.51	3.00	V
			$T_{vj} = 150^\circ\text{C}$	-	1.81	3.40	V
Reverse recovery time	$t_{rr}$	$V_{GE} = \pm 15\text{ V};$	$T_{vj} = 25^\circ\text{C}$	-	-	115	ns
			$T_{vj} = 150^\circ\text{C}$	-	-	165	
Peak reverse current	$I_{RM}$	$V_{CE} = 600\text{ V}; I_{Cmax} = 150\text{ A};$	$T_{vj} = 25^\circ\text{C}$	-	-	52	A
			$T_{vj} = 150^\circ\text{C}$	-	-	110	
Recovered charge	$Q_r$	$L_s = 56\text{ nH}; R_{Gon} = 2.2\ \Omega.$	$T_{vj} = 25^\circ\text{C}$	-	-	4.0	$\mu\text{C}$
			$T_{vj} = 150^\circ\text{C}$	-	-	13.0	
Reverse recovery energy	$E_{rec}$		$T_{vj} = 25^\circ\text{C}$	-	-	1.5	mJ
			$T_{vj} = 150^\circ\text{C}$	-	-	4.0	
Threshold voltage	$V_{(T0)}$	$T_{vj} = 150^\circ\text{C}; V_{GE} = 0; I_{CE1} = 38\text{ A};$		-	-	0.86	V
Forward slope resistance	$r_T$	$I_{CE2} = 150\text{ A}; t_u = 1000\ \mu\text{s}$		-	-	6.63	$\text{m}\Omega$
Thermal resistance junction to case	$R_{th(jc-D)}$	$\text{DC}; I_{CE} = 100 \pm 10\text{ A}; I_{test} = 0.5\text{ A}; V_{GE} = +15\text{ V}.$		-	-	0.310	K/W

Module							
Pin resistance	$R_{Pxy}$	$T_{vj} = 25^{\circ}\text{C}$ .	$R_{P12}$	-	0.47	0.50	m $\Omega$
			$R_{P13}$	-	0.66	0.66	
Parasitic inductance between terminals	$L_{Pce}$			-	27	-	nH
Thermal resistance case to heatsink	$R_{thCH}$	per module		-	0.02	0.04	K/W
Mounting torque for screws to heatsink	$M_s$	to heatsink M6		3.00	-	5.00	Nm
Mounting torque for terminal screws	$M_t$	to terminals M5		1.80	2.00	2.20	Nm
Weight	$W$			-	150	170	g

" - " — data will be refined as additional tests are conducted and statistics are collected.

**Notes:**

- Insulating material operating temperature 125°C max;
- Case temperature 125°C max;
- The recommended operating junction temperature  $T_{vj\ op} = -40\dots+150^{\circ}\text{C}$ .

